# MICROCHIP

# MX554BNN20M1416

## Ultra-Low Jitter 20.141602MHz LVCMOS XO

#### ClockWorks® FUSION

# **General Description**

The MX554BNN20M1416 is an ultra-low phase jitter XO with LVCMOS output optimized for high line rate applications.

# **Applications**

- Optical communications
- Forward error correction (FEC) rates
- FPGA SERDES reference clock

## Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T <sub>s</sub> )	65°C to +125°C
Storage Temperature (T <sub>S</sub> ) ESD Machine Model	200V
ESD Rating (HBM)	2kV

## **Features**

- 20.141602MHz LVCMOS
- Supports FEC line rate
- Typical phase noise:
  - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

# Operating Ratings<sup>2</sup>

Supply Voltage (VIN)	+2.375V to +3.63V
Ambient Temperature (TA)	40°C to +85°C
Junction Thermal Resistance	
LGA (T <sub>IA</sub> ) Still Air	58°C/W
` JA´	

## **Electrical Characteristics**

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, output terminated with 50 Ohms to VDD/2.3

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			20.141602		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		500	ps
	Duty Cycle		45		55	%
VIH	Input High Voltage	3.3V Operation	2		VDD + 0.3	V
VIL	Input Low Voltage	3.3V Operation	-0.3		0.8	V
VOH	Output High Voltage	LVCMOS output levels	VDD - 0.8			V
VOL	Output Low Voltage	LVCMOS output levels			0.6	V

#### Notes

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- 3. Guaranteed after thermal equilibrium.
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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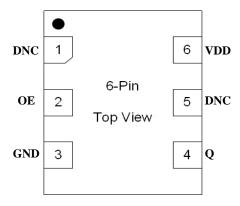
November 27, 2019 MX554BN2-8540 Revision 1.0 tcghelp@microchip.com

# **Ordering Information**

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554BNN20M1416	MX554B	NN0201	Tube	6-Pin 5mm x 3.2mm LGA
MX554BNN20M1416-TR	MX554B	NN0201	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

# **Pin Configuration**



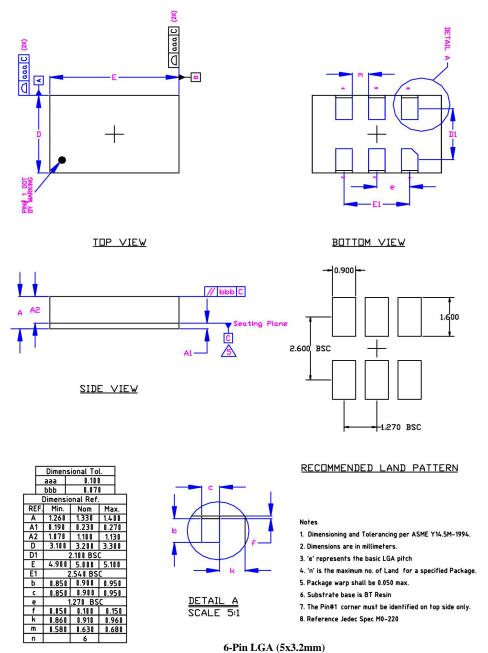
# **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	DNC			Make no connection, leave floating.
2	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down (Internal)
3	GND	PWR		Power Supply Ground
4, 5	Q, DNC	O, SE	LVCMOS	Clock Output Frequency = 20.141602MHz
6	VDD	PWR		Power Supply

# **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A	
Moisture Resistance	MIL-STD-883, Method 1004	
Mechanical Shock	MIL-STD-883, Method 2002, Condition E	
Mechanical Vibration	MIL-STD-883, Method 2007, Condition C	
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)	
Hazardous Substance	Pb-Free / RoHS / Green Compliant	
Solderability	JESD22-B102-D Method 2 (Preconditioning E)	
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D	
Gross Leak	MIL-STD-883, Method 1014, Condition C	
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s	
Solvent Resistance	MIL-STD-202, Method 215	

## Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



#### Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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